Docket No.: TSL1534 FORM PTO-1595 (Modified) U.S. DEPARTMENT OF COMMERCE 08-08-2000 (Rev. 6-93) Patent and Trademark Office OMB No. 0651-0011 (exp.4/94) Copyright 1996-97 LegalStar P08A/REV02 Tab settings → → To the Honorable Commission 101425626 ached original documents or copy thereof. of Patent: Name of conveying party(ies): 2. Name and address of receiving party(ies): HIROJI ENAMI Name: Dow Corning Toray Silicone Company, Limited AKIHIRO NAKAMURA Address: 4th Floor, AIG Building, 1-1-3, Marunouchi, Chiyoda-ku, ☐ Yes 🏻 No Additional names(s) of conveying party(ies) 3. Nature of conveyance: ☐ Merger ★ Assignment City: Tokyo 100-0005 State/Prov.: ☐ Security Agreement ☐ Change of Name Country: Japan ☐ Other _____ ZIP: Execution Date: April 18, 2000 ☐ Yes ⊠ No Additional name(s) & address(es) 4. Application number(s) or registration numbers(s): If this document is being filed together with a new application, the execution date of the application is: Filing date B. Patent No.(s) Patent Application No. April 13, 2000 09/548,861 Yes X No Additional numbers 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: Name: Larry A. Milco 7. Total fee (37 CFR 3.41):.....\$ 40.00 41,196 Registration No. ☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account Address: Dow Corning Corporation Authorized to be charged to deposit account Intellectual Property Dept. - Mail CO1232 P.O. Box 994, 2200 W. Salzburg Road 8. Deposit account number: City: Midland State/Prov.: MI 04-1520 Country: US ZIP: 48686-0994 DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Fraga mila 07/17/00 Larry A. Milco Name of Person Signing Total number of pages including cover sheet, attachments, and

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ASSIGNMENT

	improvements in	n SILICON	E GEL COMPOSI	KAMURA have invented TION for which application
			•	, 2000; and,
WHEREA	S, DOW CORNI 1-1-3, Marunouch ention and said ap	ING TORA ni, Chiyoda- pplication ar	Y SILICONE CON- ku, Tokyo 100-000 nd any and all Lette	MPANY, LTD., of 4th 05, Japan, is desirous of ers Patent that may be
and in consideration of considerations, to us in COMPANY, LIMITE transferred and set over DOW CORNING TO and exclusive right, tit Patent of the United Stand to any and all Unites used for the said investment.	f the sum of	e said DOW which is her esents do se COMPAN and to said d in and to a Patent and d to hold fo fully and en	Yen, and other government of CORNING TOR reby acknowledged ell, assign, transfer Y, LTD., its successinvention and said any Divisions and creissues and extensor its own use and by Cornel of the corn	ERN, be it known that for good and valuable AY SILICONE I, we have sold, assigned, and set over unto the said ssors, and assigns, the full application for Letters Continuations thereof and in sions thereof that may be behoof and the use and might be enjoyed by us if
to issue the said Letter CORNING TORAY S	s Patent and any I ILICONE COMF	reissues and PANY, LTE	l extensions thereo O. as assigns of the	of Patents and Trademarks of to the said DOW entire right, title and eatent issued therefor or

thereupon; and

HEREBY AGREE to execute all instruments and documents within our power which may be necessary for the carrying out of this assignment in full; and to execute any divisional or continuing application or applications which may be necessary or proper to obtain full protection on the invention hereby assigned; and to execute any and all supplemental oaths and preliminary statements should the same be proper and necessary in the prosecution of the aforesaid applications; and

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HEREBY FURTHER ASSIGN unto the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors, and assigns, the whole right, title and interest in and to the invention disclosed in the said application throughout all countries foreign to the United States, and do hereby ratify any acts of the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns, in applying for patents therefor in its own name in countries where such procedure is proper and do agree to execute applications for said invention in the several countries where it is necessary that the same be executed by the inventors, and to execute assignments of such applications and the patents to be obtained therefor to the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns.

IN WITNESS WHEREOF I have hereunto set my hand
Hivoji Enami HIROJI ENAMI
HIROJI ÉNAMI
Dated: April 18, 2000
This is to certify that HIROJI ENAMI has signed this document in my presence this 18th day of April , 2000, Japan.
Signature of Witness
Signature of Witness
HIROMI FUJITA
IN WITNESS WHEREOF I have hereunto set my hand
AKIHIRO NAKAMURA
Dated: <u>Apvil 18. 2000</u>
This is to certify that AKIHIRO NAKAMURA has signed this document in my presence this 18th day of April , 2000, Japan.
Signature of Witness HIROMI FUJITA

PATENT RECORDED: 07/21/2000 REEL: 010970 FRAME: 0143